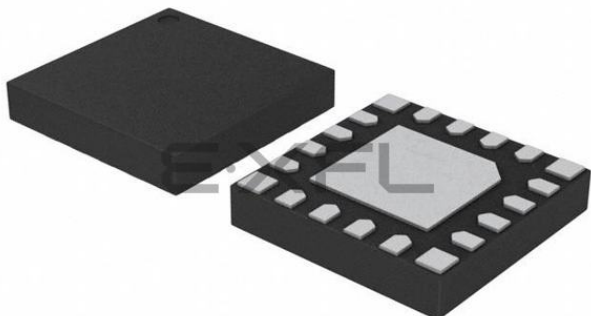




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Details

Product Status	Obsolete
Core Processor	CIP-51 8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I ² C), SPI, UART/USART
Peripherals	Brown-out Detect/Reset, Cap Sense, POR, PWM, WDT
Number of I/O	16
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-UFQFN Exposed Pad
Supplier Device Package	20-QFN (3x3)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f991-gmr

Table 3.5. PCB Land Pattern

Dimension	MIN	MAX
C1	3.90	4.00
C2	3.90	4.00
E	0.50 BSC	
X1	0.20	0.30
X2	2.70	2.80
Y1	0.65	0.75
Y2	2.70	2.80

Notes:

General

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. This Land Pattern Design is based on the IPC-7351 guidelines.

Solder Mask Design

1. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 μ m minimum, all the way around the pad.

Stencil Design

1. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
2. The stencil thickness should be 0.125 mm (5 mils).
3. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.
4. A 2x2 array of 1.10 mm x 1.10 mm openings on 1.30 mm pitch should be used for the center ground pad.

Card Assembly

1. A No-Clean, Type-3 solder paste is recommended.
2. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

Table 4.12. Voltage Reference Electrical Characteristics

V_{DD} = 1.8 to 3.6 V, -40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Internal High-Speed Reference (REFSL[1:0] = 11)					
Output Voltage	-40 to +85 °C, V_{DD} = 1.8–3.6 V	1.62	1.65	1.68	V
VREF Turn-on Time		—	—	1.5	μs
Supply Current	Normal Power Mode	—	260	—	μA
	Low Power Mode	—	140	—	
External Reference (REFSL[1:0] = 00, REFOE = 0)					
Input Voltage Range		0	—	V_{DD}	V
Input Current	Sample Rate = 300 ksps; V_{REF} = 3.0 V	—	5.25	—	μA

Table 4.16. Capacitive Sense Electrical CharacteristicsV_{DD} = 1.8 to 3.6 V; T_A = –40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Single Conversion Time ¹	12-bit Mode	20	25	40	μs
	13-bit Mode (default)	21	27	42.5	
	14-bit Mode	23	29	45	
	16-bit Mode	26	33	50	
Number of Channels	24-pin Packages	17			Channels
	20-pin Packages	16			
Capacitance per Code	Default Configuration	—	1	—	fF
Maximum External Capacitive Load	CS0CG = 111b (Default)	—	45	—	pF
	CS0CG = 000b	—	500	—	pF
Maximum External Series Impedance	CS0CG = 111b (Default)	—	50	—	kΩ
Power Supply Current	CS module bias current, 25 °C	—	50	60	μA
	CS module alone, maximum code output, 25 °C	—	90	125	μA
	Wake-on-CS threshold (suspend mode with regulator and CS module on) ³	—	130	180	μA
Notes:					
1. Conversion time is specified with the default configuration.					
2. RMS Noise is equivalent to one standard deviation. Peak-to-peak noise encompasses ±3.3 standard deviations. The RMS noise value is specified with the default configuration.					
3. Includes only current from regulator, CS module, and MCU in suspend mode.					

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SFR Definition 7.2. CPT0MD: Comparator 0 Mode Selection

Bit	7	6	5	4	3	2	1	0
Name			CP0RIE	CP0FIE			CP0MD[1:0]	
Type	R/W	R	R/W	R/W	R	R	R/W	
Reset	1	0	0	0	0	0	1	0

SFR Page = 0x0; SFR Address = 0x9D

Bit	Name	Function
7	Reserved	Read = 1b, Must Write 1b.
6	Unused	Read = 0b, Write = don't care.
5	CP0RIE	Comparator0 Rising-Edge Interrupt Enable. 0: Comparator0 Rising-edge interrupt disabled. 1: Comparator0 Rising-edge interrupt enabled.
4	CP0FIE	Comparator0 Falling-Edge Interrupt Enable. 0: Comparator0 Falling-edge interrupt disabled. 1: Comparator0 Falling-edge interrupt enabled.
3:2	Unused	Read = 00b, Write = don't care.
1:0	CP0MD[1:0]	Comparator0 Mode Select These bits affect the response time and power consumption for Comparator0. 00: Mode 0 (Fastest Response Time, Highest Power Consumption) 01: Mode 1 10: Mode 2 11: Mode 3 (Slowest Response Time, Lowest Power Consumption)

C8051F99x-C8051F98x

14.4. Determining the Device Part Number at Run Time

In many applications, user software may need to determine the MCU part number at run time in order to determine the hardware capabilities. The part number can be determined by reading the value of the DEVICEID Special Function Register.

The value of the DEVICEID register can be decoded as follows:

0xD0—C8051F990
0xD1—C8051F991
0xD6—C8051F996
0xD2—C8051F997

0xD3—C8051F980
0xD4—C8051F981
0xD5—C8051F982
0xD7—C8051F983
0xD8—C8051F985
0xD9—C8051F986
0xDA—C8051F987
0xDB—C8051F988
0xDC—C8051F989

SFR Definition 14.1. DEVICEID: Device Identification

Bit	7	6	5	4	3	2	1	0
Name	DEVICEID[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Page = 0xF; SFR Address = 0xE3

Bit	Name	Function
7:0	DEVICEID[7:0]	Device Identification. These bits contain a value that can be decoded to determine the device part number.

SFR Definition 14.2. REVID: Revision Identification

Bit	7	6	5	4	3	2	1	0
Name	REVID[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Page = 0xF; SFR Address = 0xE2

Bit	Name	Function
7:0	REVID[7:0]	Revision Identification. These bits contain a value that can be decoded to determine the silicon revision. For example, 0x00 for Rev A, 0x01 for Rev B, 0x02 for Rev C, etc.

SFR Definition 16.1. CRC0CN: CRC0 Control

Bit	7	6	5	4	3	2	1	0
Name					CRC0INIT	CRC0VAL		CRC0PNT
Type	R	R	R	R	R/W	R/W	R	R/W
Reset	0	0	0	1	0	0	0	0

SFR Page = All; SFR Address = 0x84

Bit	Name	Function
7:4	Unused	Read = 0001b; Write = Don't Care.
3	CRC0INIT	CRC0 Result Initialization Bit. Writing a 1 to this bit initializes the entire CRC result based on CRC0VAL.
2	CRC0VAL	CRC0 Set Value Initialization Bit. This bit selects the set value of the CRC result. 0: CRC result is set to 0x00000000 on write of 1 to CRC0INIT. 1: CRC result is set to 0xFFFFFFFF on write of 1 to CRC0INIT.
1	Unused	Read = 0b; Write = Don't Care.
0	CRC0PNT	CRC0 Result Pointer. Specifies the byte of the CRC result to be read/written on the next access to CRC0DAT. The value of these bits will auto-increment upon each read or write. 0: CRC0DAT accesses bits 7–0 of the 16-bit CRC result. 1: CRC0DAT accesses bits 15–8 of the 16-bit CRC result.

Note: Upon initiation of an automatic CRC calculation, the three cycles following a write to CRC0CN that initiate a CRC operation must only contain instructions which execute in the same number of cycles as the number of bytes in the instruction. An example of such an instruction is a 3-byte MOV that targets the CRC0FLIP register. When programming in C, the dummy value written to CRC0FLIP should be a non-zero value to prevent the compiler from generating a 2-byte MOV instruction.

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SFR Definition 16.5. CRC0CNT: CRC0 Automatic Flash Sector Count

Bit	7	6	5	4	3	2	1	0
Name				CRC0CNT[4:0]				
Type	R	R	R	R/W				
Reset	0	0	0	0	0	0	0	0

SFR Page = All; SFR Address = 0x9A

Bit	Name	Function
7:5	Unused	Read = 000b; Write = Don't Care.
4:0	CRC0CNT[4:0]	Automatic CRC Calculation Block Count. These bits specify the number of Flash blocks to include in an automatic CRC calculation. The last address of the last Flash block included in the automatic CRC calculation is $(CRC0ST + CRC0CNT) \times \text{Block Size} - 1$. Notes: 1. The block size is 256 bytes. 2. The maximum number of blocks that may be computed in a single operation is 31. To compute a CRC on all 32 blocks, perform one operation on 31 blocks, then perform a second operation on 1 block without clearing the CRC result.

18. Reset Sources

Reset circuitry allows the controller to be easily placed in a predefined default condition. On entry to this reset state, the following occur:

- CIP-51 halts program execution
- Special Function Registers (SFRs) are initialized to their defined reset values
- External Port pins are forced to a known state
- Interrupts and timers are disabled

All SFRs are reset to the predefined values noted in the SFR descriptions. The contents of RAM are unaffected during a reset; any previously stored data is preserved as long as power is not lost. Since the stack pointer SFR is reset, the stack is effectively lost, even though the data on the stack is not altered.

The Port I/O latches are reset to 0xFF (all logic ones) in open-drain mode. Weak pullups are enabled during and after the reset. For power-on resets, the $\overline{\text{RST}}$ pin is high-impedance with the weak pull-up off until the device exits the reset state. For V_{DD} Monitor resets, the $\overline{\text{RST}}$ pin is driven low until the device exits the reset state.

On exit from the reset state, the program counter (PC) is reset, and the system clock defaults to an internal oscillator. Refer to Section “19. Clocking Sources” on page 188 for information on selecting and configuring the system clock source. The Watchdog Timer is enabled with the system clock divided by 12 as its clock source (Section “26.4. Watchdog Timer Mode” on page 311 details the use of the Watchdog Timer). Program execution begins at location 0x0000.

Important Note: On device reset or upon waking up from Sleep mode, address 0x0000 of external memory may be overwritten by an indeterminate value. The indeterminate value is 0x00 in most situations. A dummy variable should be placed at address 0x0000 in external memory to ensure that the application firmware does not store any data that needs to be retained during sleep or reset at this memory location.

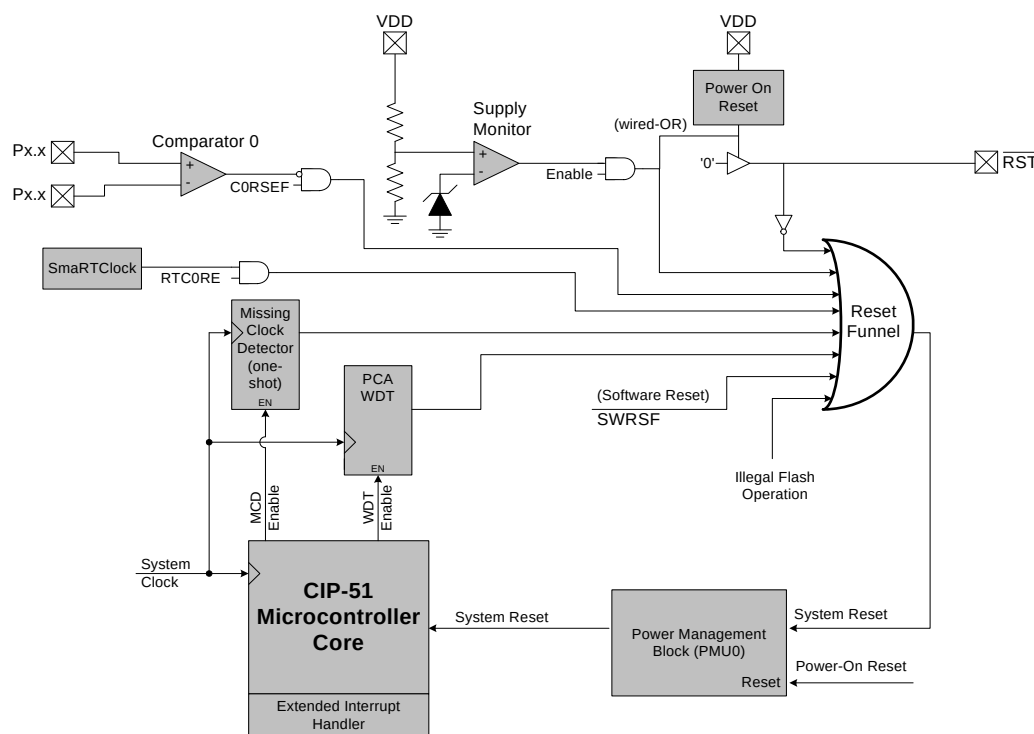


Figure 18.1. Reset Sources

18.8. SmaRTClock (Real Time Clock) Reset

The SmaRTClock can generate a system reset on two events: SmaRTClock Oscillator Fail or SmaRTClock Alarm. The SmaRTClock Oscillator Fail event occurs when the SmaRTClock Missing Clock Detector is enabled and the SmaRTClock clock is below approximately 20 kHz. A SmaRTClock alarm event occurs when the SmaRTClock Alarm is enabled and the SmaRTClock timer value matches the ALARMn registers. The SmaRTClock can be configured as a reset source by writing a 1 to the RTCORE flag (RSTSRC.7). The SmaRTClock reset remains functional even when the device is in the low power Suspend or Sleep mode. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

18.9. Software Reset

Software may force a reset by writing a 1 to the SWRSF bit (RSTSRC.4). The SWRSF bit will read 1 following a software forced reset. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

19. Clocking Sources

C8051F99x-C8051F98x devices include a programmable precision internal oscillator, an external oscillator drive circuit, a low power internal oscillator, and a SmartClock real time clock oscillator. The precision internal oscillator can be enabled/disabled and calibrated using the OSCICN and OSCICL registers, as shown in Figure 19.1. The external oscillator can be configured using the OSCXCN register. The low power internal oscillator is automatically enabled and disabled when selected and deselected as a clock source. SmartClock operation is described in the SmartClock oscillator chapter.

The system clock (SYSCLK) can be derived from the precision internal oscillator, external oscillator, low power internal oscillator, low power internal oscillator divided by 8, or SmartClock oscillator. The global clock divider can generate a system clock that is 1, 2, 4, 8, 16, 32, 64, or 128 times slower than the selected input clock source. Oscillator electrical specifications can be found in the Electrical Specifications Chapter.

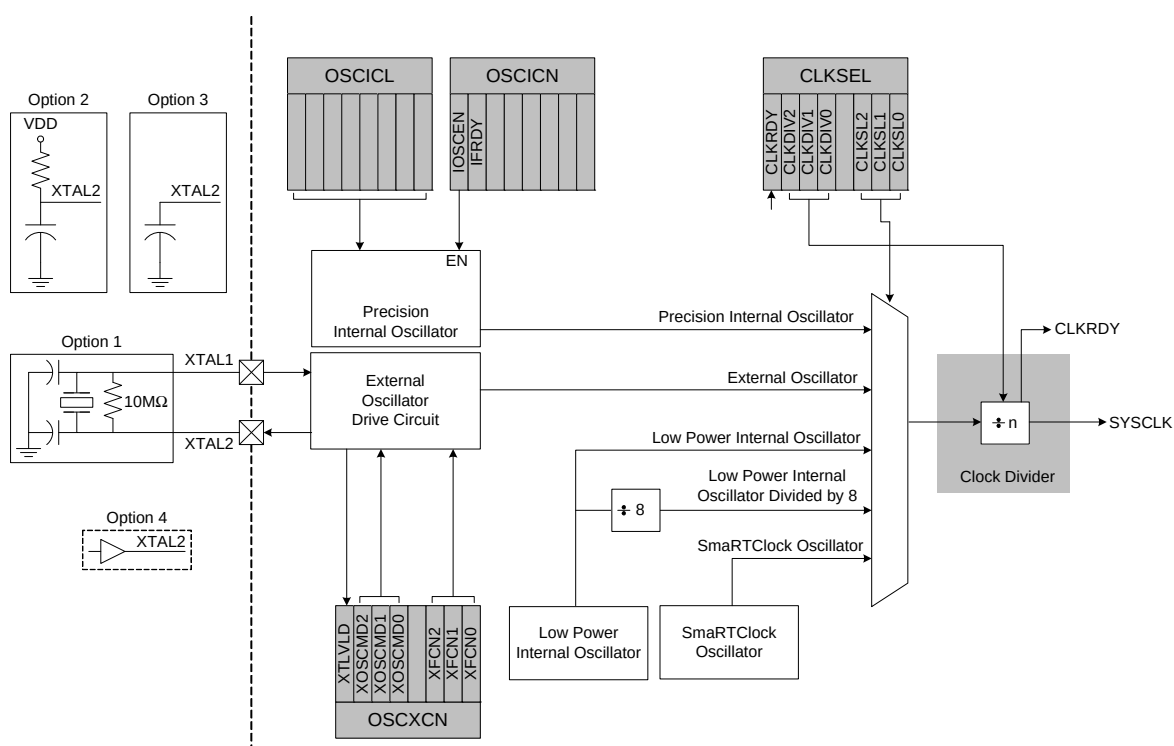


Figure 19.1. Clocking Sources Block Diagram

The proper way of changing the system clock when both the clock source and the clock divide value are being changed is as follows:

If switching from a fast “undivided” clock to a slower “undivided” clock:

1. Change the clock divide value.
2. Poll for CLKRDY > 1.
3. Change the clock source.

If switching from a slow “undivided” clock to a faster “undivided” clock:

1. Change the clock source.
2. Change the clock divide value.
3. Poll for CLKRDY > 1.

20. SmaRTClock (Real Time Clock)

C8051F99x-C8051F98x devices include an ultra low power 32-bit SmaRTClock Peripheral (Real Time Clock) with alarm. The SmaRTClock has a dedicated 32 kHz oscillator that can be configured for use with or without a crystal. No external resistor or loading capacitors are required. The on-chip loading capacitors are programmable to 16 discrete levels allowing compatibility with a wide range of crystals. The SmaRTClock can operate directly from a 1.8–3.6 V battery voltage and remains operational even when the device goes into its lowest power down mode. The SmaRTClock output can be buffered and routed to a GPIO pin to provide an accurate, low frequency clock to other devices while the MCU is in its lowest power down mode (see “PMU0MD: Power Management Unit Mode” on page 170 for more details). C8051F99x-C8051F98x devices also support an ultra low power internal LFO that reduces sleep mode current.

The SmaRTClock allows a maximum of 36 hour 32-bit independent time-keeping when used with a 32.768 kHz Watch Crystal. The SmaRTClock provides an Alarm and Missing SmaRTClock events, which could be used as reset or wakeup sources. See Section “18. Reset Sources” on page 181 and Section “15. Power Management” on page 162 for details on reset sources and low power mode wake-up sources, respectively.

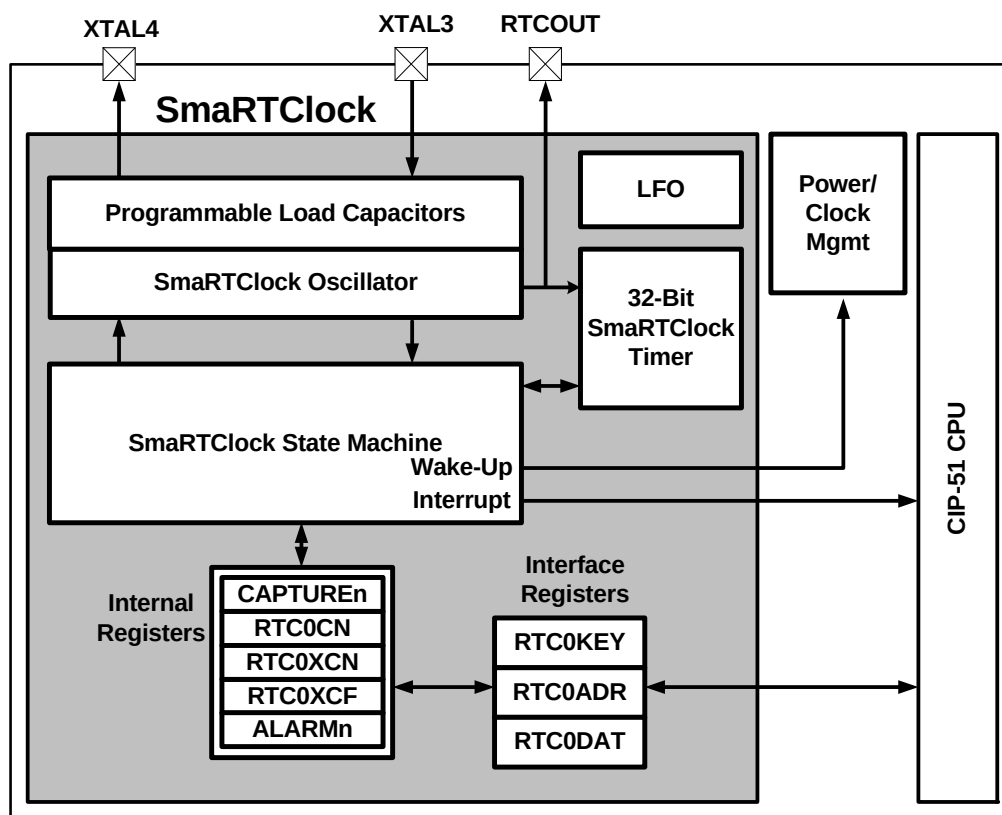


Figure 20.1. SmaRTClock Block Diagram

Internal Register Definition 20.7. CAPTUREn: SmaRTClock Timer Capture

Bit	7	6	5	4	3	2	1	0
Name	CAPTURE[31:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SmaRTClock Addresses: CAPTURE0 = 0x00; CAPTURE1 = 0x01; CAPTURE2 = 0x02; CAPTURE3: 0x03.

Bit	Name	Function
7:0	CAPTURE[31:0]	SmaRTClock Timer Capture. These 4 registers (CAPTURE3–CAPTURE0) are used to read or set the 32-bit SmaRTClock timer. Data is transferred to or from the SmaRTClock timer when the RTC0SET or RTC0CAP bits are set.

Note: The least significant bit of the timer capture value is in CAPTURE0.0.

Internal Register Definition 20.8. ALARMn: SmaRTClock Alarm Programmed Value

Bit	7	6	5	4	3	2	1	0
Name	ALARM[31:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SmaRTClock Addresses: ALARM0 = 0x08; ALARM1 = 0x09; ALARM2 = 0x0A; ALARM3 = 0x0B

Bit	Name	Function
7:0	ALARM[31:0]	SmaRTClock Alarm Programmed Value. These 4 registers (ALARM3–ALARM0) are used to set an alarm event for the SmaRTClock timer. The SmaRTClock alarm should be disabled (RTC0AEN=0) when updating these registers.

Note: The least significant bit of the alarm programmed value is in ALARM0.0.

SFR Definition 21.6. P1MASK: Port1 Mask Register

Bit	7	6	5	4	3	2	1	0
Name	P1MASK[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Page= 0x0; SFR Address = 0xBF

Bit	Name	Function
7:0	P1MASK[7:0]	Port 1 Mask Value. Selects P1 pins to be compared to the corresponding bits in P1MAT. 0: P1.n pin logic value is ignored and cannot cause a Port Mismatch event. 1: P1.n pin logic value is compared to P1MAT.n.

SFR Definition 21.7. P1MAT: Port1 Match Register

Bit	7	6	5	4	3	2	1	0
Name	P1MAT[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Page = 0x0; SFR Address = 0xCF

Bit	Name	Function
7:0	P1MAT[7:0]	Port 1 Match Value. Match comparison value used on Port 1 for bits in P1MASK which are set to 1. 0: P1.n pin logic value is compared with logic LOW. 1: P1.n pin logic value is compared with logic HIGH.

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SFR Definition 21.17. P1DRV: Port1 Drive Strength

Bit	7	6	5	4	3	2	1	0
Name	P1DRV[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Page = 0xF; SFR Address = 0x9B

Bit	Name	Function
7:0	P1DRV[7:0]	Drive Strength Configuration Bits for P1.7–P1.0 (respectively). Configures digital I/O Port cells to high or low output drive strength. 0: Corresponding P1.n Output has low output drive strength. 1: Corresponding P1.n Output has high output drive strength.

SFR Definition 21.18. P2: Port2

Bit	7	6	5	4	3	2	1	0
Name	P2							
Type	R/W	R	R	R	R	R	R	R
Reset	1	0	0	0	0	0	0	0

SFR Page = All; SFR Address = 0xA0; Bit-Addressable

Bit	Name	Description	Read	Write
7	P2	Port 2 Data. Sets the Port latch logic value or reads the Port pin logic state in Port cells configured for digital I/O.	0: Set output latch to logic LOW. 1: Set output latch to logic HIGH.	0: P2.7 Port pin is logic LOW. 1: P2.7 Port pin is logic HIGH.
6:0	Unused	Read = 0000000b; Write = Don't Care.		

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SFR Definition 22.3. SMB0ADR: SMBus Slave Address

Bit	7	6	5	4	3	2	1	0
Name	SLV[6:0]							GC
Type	R/W							R/W
Reset	0	0	0	0	0	0	0	0

SFR Page = 0x0; SFR Address = 0xF4

Bit	Name	Function
7:1	SLV[6:0]	SMBus Hardware Slave Address. Defines the SMBus Slave Address(es) for automatic hardware acknowledgement. Only address bits which have a 1 in the corresponding bit position in SLVM[6:0] are checked against the incoming address. This allows multiple addresses to be recognized.
0	GC	General Call Address Enable. When hardware address recognition is enabled (EHACK = 1), this bit will determine whether the General Call Address (0x00) is also recognized by hardware. 0: General Call Address is ignored. 1: General Call Address is recognized.

SFR Definition 22.4. SMB0ADM: SMBus Slave Address Mask

Bit	7	6	5	4	3	2	1	0
Name	SLVM[6:0]							EHACK
Type	R/W							R/W
Reset	1	1	1	1	1	1	1	0

SFR Page = 0x0; SFR Address = 0xF5

Bit	Name	Function
7:1	SLVM[6:0]	SMBus Slave Address Mask. Defines which bits of register SMB0ADR are compared with an incoming address byte, and which bits are ignored. Any bit set to 1 in SLVM[6:0] enables comparisons with the corresponding bit in SLV[6:0]. Bits set to 0 are ignored (can be either 0 or 1 in the incoming address).
0	EHACK	Hardware Acknowledge Enable. Enables hardware acknowledgement of slave address and received data bytes. 0: Firmware must manually acknowledge all incoming address and data bytes. 1: Automatic Slave Address Recognition and Hardware Acknowledge is Enabled.

23. UART0

UART0 is an asynchronous, full duplex serial port offering modes 1 and 3 of the standard 8051 UART. Enhanced baud rate support allows a wide range of clock sources to generate standard baud rates (details in Section “23.1. Enhanced Baud Rate Generation” on page 258). Received data buffering allows UART0 to start reception of a second incoming data byte before software has finished reading the previous data byte.

UART0 has two associated SFRs: Serial Control Register 0 (SCON0) and Serial Data Buffer 0 (SBUF0). The single SBUF0 location provides access to both transmit and receive registers. **Writes to SBUF0 always access the Transmit register. Reads of SBUF0 always access the buffered Receive register; it is not possible to read data from the Transmit register.**

With UART0 interrupts enabled, an interrupt is generated each time a transmit is completed (TI0 is set in SCON0), or a data byte has been received (RI0 is set in SCON0). The UART0 interrupt flags are not cleared by hardware when the CPU vectors to the interrupt service routine. They must be cleared manually by software, allowing software to determine the cause of the UART0 interrupt (transmit complete or receive complete).

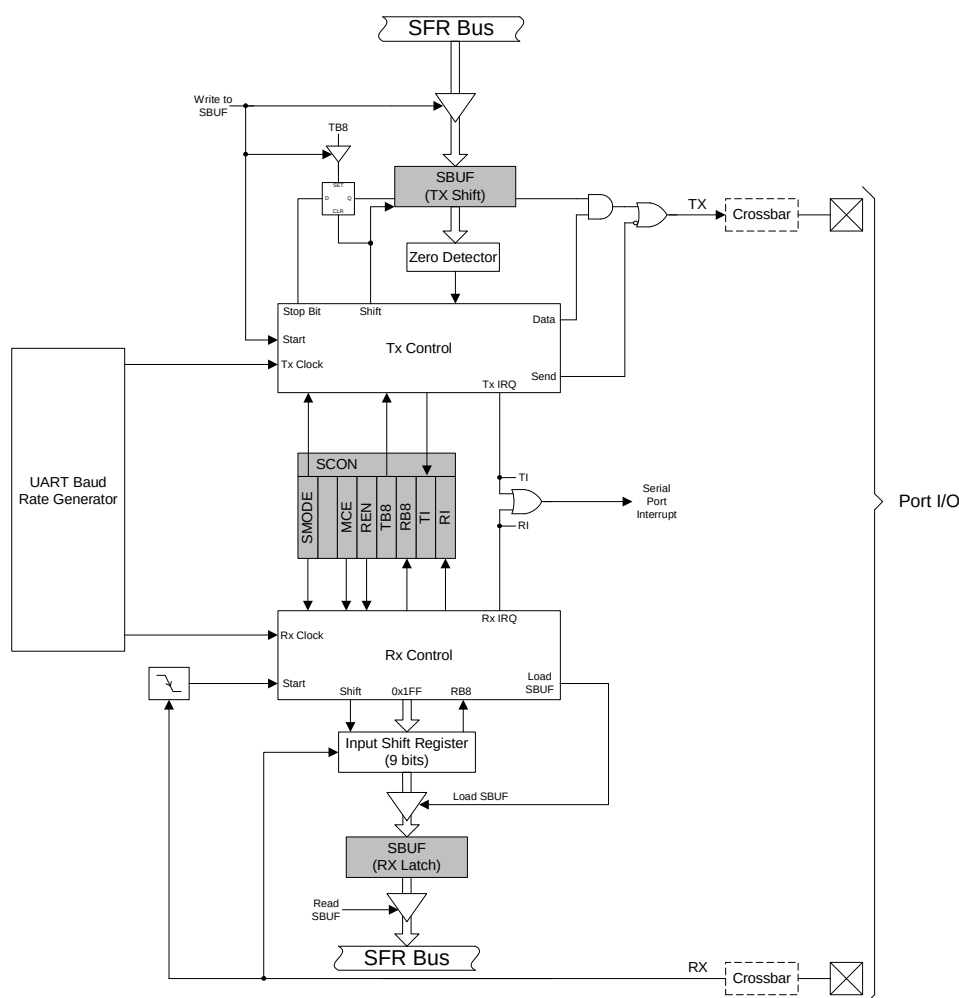
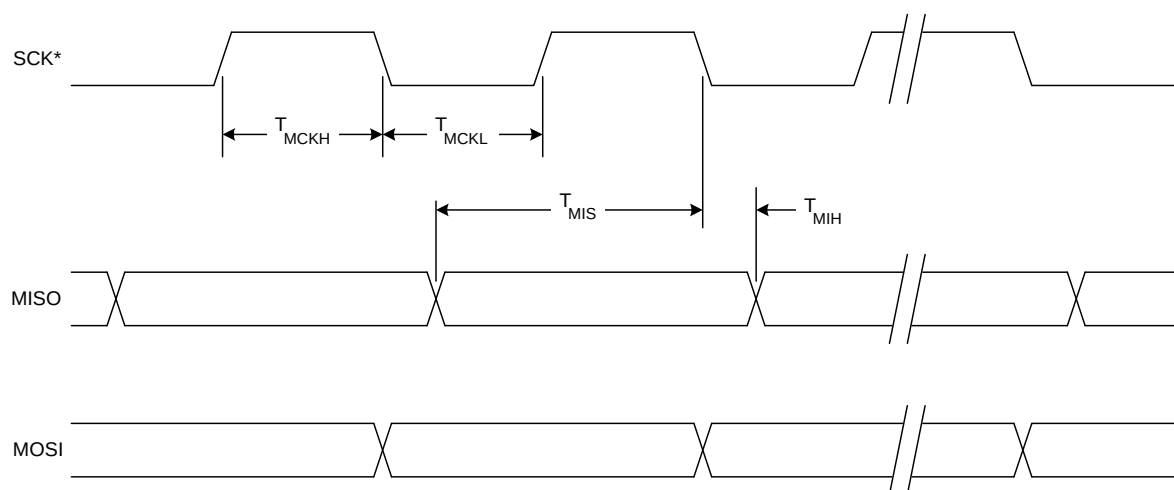
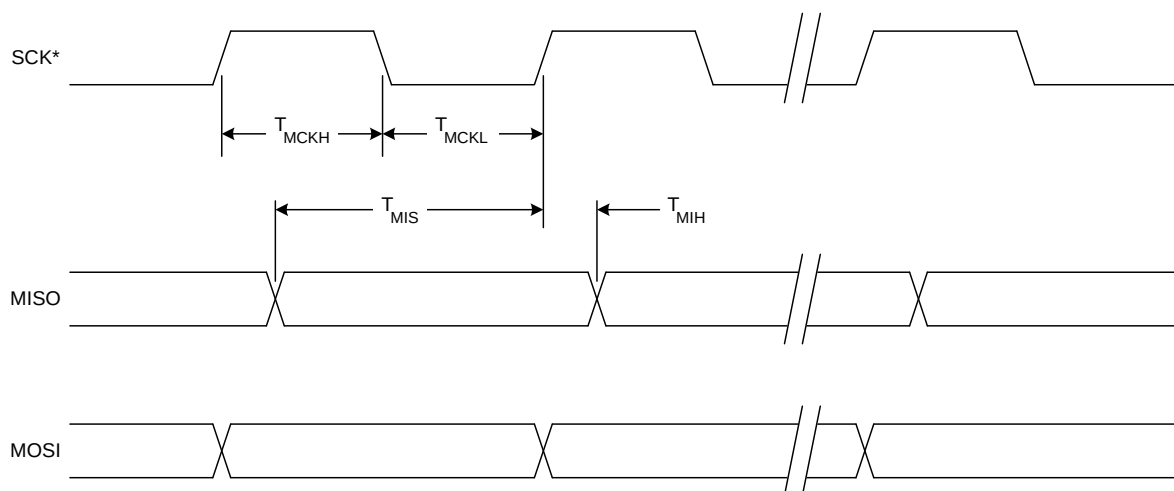


Figure 23.1. UART0 Block Diagram



* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.

Figure 24.8. SPI Master Timing (CKPHA = 0)



* SCK is shown for CKPOL = 0. SCK is the opposite polarity for CKPOL = 1.

Figure 24.9. SPI Master Timing (CKPHA = 1)

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SFR Definition 26.7. PCA0CPLn: PCA Capture Module Low Byte

Bit	7	6	5	4	3	2	1	0
Name	PCA0CPn[7:0]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Addresses: PCA0CPL0 = 0xFB, PCA0CPL1 = 0xE9, PCA0CPL2 = 0xEB

SFR Pages: PCA0CPL0 = 0x0, PCA0CPL1 = 0x0, PCA0CPL2 = 0x0,

Bit	Name	Function
7:0	PCA0CPn[7:0]	PCA Capture Module Low Byte. The PCA0CPLn register holds the low byte (LSB) of the 16-bit capture module n. This register address also allows access to the low byte of the corresponding PCA channel's auto-reload value for 9, 10, or 11-bit PWM mode. The ARSEL bit in register PCA0PWM controls which register is accessed.
Note: A write to this register will clear the module's ECOMn bit to a 0.		

SFR Definition 26.8. PCA0CPHn: PCA Capture Module High Byte

Bit	7	6	5	4	3	2	1	0
Name	PCA0CPn[15:8]							
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Addresses: PCA0CPH0 = 0xFC, PCA0CPH1 = 0xEA, PCA0CPH2 = 0xEC

SFR Pages: PCA0CPH0 = 0x0, PCA0CPH1 = 0x0, PCA0CPH2 = 0x0,

Bit	Name	Function
7:0	PCA0CPn[15:8]	PCA Capture Module High Byte. The PCA0CPHn register holds the high byte (MSB) of the 16-bit capture module n. This register address also allows access to the high byte of the corresponding PCA channel's auto-reload value for 9, 10, or 11-bit PWM mode. The ARSEL bit in register PCA0PWM controls which register is accessed.
Note: A write to this register will set the module's ECOMn bit to a 1.		

27.2. C2 Pin Sharing

The C2 protocol allows the C2 pins to be shared with user functions so that in-system debugging and Flash programming may be performed. This is possible because C2 communication is typically performed when the device is in the halt state, where all on-chip peripherals and user software are stalled. In this halted state, the C2 interface can safely “borrow” the C2CK ($\overline{\text{RST}}$) and C2D pins. In most applications, external resistors are required to isolate C2 interface traffic from the user application. A typical isolation configuration is shown in Figure 27.1.

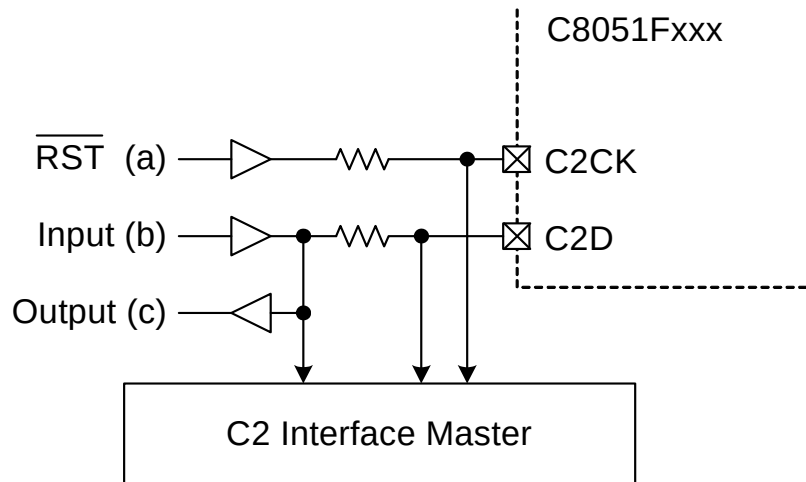


Figure 27.1. Typical C2 Pin Sharing

The configuration in Figure 27.1 assumes the following:

1. The user input (b) cannot change state while the target device is halted.
2. The $\overline{\text{RST}}$ pin on the target device is used as an input only.

Additional resistors may be necessary depending on the specific application.